



3SPGroup will attend OFC/NFOEC 2014

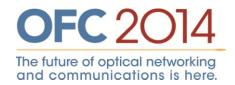
March 11-13, 2014
Moscone Center, San Francisco
- Booth 1434 -

Nozay, March 1, 2014 – 3SPGroup will attend OFC/NFOEC 2014 which will be held at the Moscone Center, in San Francisco, CA from March 11-13.

During this important show, 3SPGroup will showcase different products for the Telecom, CATV and FTTH markets, such as: DPSK, GFF/FBG, EDFA, VGA, Raman Amplifier, TOSA, 980 nm pump laser diode, 14xx nm Raman pump, (1+1) x 1 pump & signal injector.

OFC - the Optical Fiber Communication Conference - and NFOEC - the National Fiber Optic Engineers Conference is the largest and most comprehensive international event for optical communications.

For additional information: www.ofcnfoec.org/home.aspx



About 3SPGroup

3SPGroup is a leading provider of innovative optical products and solutions for Lasers, Sensing & Telecom markets. The Group designs, manufactures, and markets high reliability active & passive optical components and modules for the telecom, sensing & laser markets. It develops ultra-reliable fiber-optic systems including high-power fused components, optical sensors and fiber laser components. Through its Avensys Solutions division, it also provides instrumentation and integrated solutions for process and environmental monitoring systems.

For more information: www.3spgroup.com

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